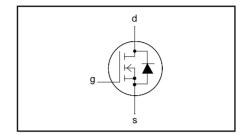
# N-channel logic level TrenchMOS<sup>TM</sup> transistor PSMN005-55B, PSMN005-55P

### **FEATURES**

- 'Trench' technology
- Very low on-state resistance
- Fast switching
- Low thermal resistance

#### **SYMBOL**



### QUICK REFERENCE DATA

$$\begin{aligned} V_{DSS} &= 55 \text{ V} \\ I_D &= 75 \text{ A} \\ R_{DS(ON)} &\leq 5.8 \text{ m}\Omega \text{ (V}_{GS} = 10 \text{ V)} \\ R_{DS(ON)} &\leq 6.3 \text{ m}\Omega \text{ (V}_{GS} = 5 \text{ V)} \end{aligned}$$

### **GENERAL DESCRIPTION**

**SiliconMAX** products use the latest Philips Trench technology to achieve the lowest possible on-state resistance in each package at each voltage rating.

### Applications:-

- d.c. to d.c. converters
- switched mode power supplies

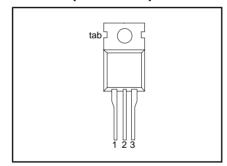
The PSMN005-55P is supplied in the SOT78 (TO220AB) conventional leaded package.

The PSMN005-55B is supplied in the SOT404 surface mounting package.

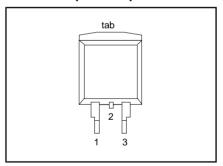
### **PINNING**

| PIN | DESCRIPTION        |  |
|-----|--------------------|--|
| 1   | gate               |  |
| 2   | drain <sup>1</sup> |  |
| 3   | source             |  |
| tab | drain              |  |
|     |                    |  |

## **SOT78 (TO220AB)**



## SOT404 (D<sup>2</sup>PAK)



#### LIMITING VALUES

Limiting values in accordance with the Absolute Maximum System (IEC 134)

| SYMBOL              | PARAMETER                | CONDITIONS  | MIN. | MAX.            | UNIT |
|---------------------|--------------------------|---|------|-----------------|------|
| $V_{DSS}$           | Drain-source voltage     | $T_i = 25 ^{\circ}\text{C} \text{ to } 175 ^{\circ}\text{C}$  | -    | 55              | V    |
| $V_{DGR}$           | Drain-gate voltage       | $T_i = 25 ^{\circ}\text{C}$ to 175 $^{\circ}\text{C}$ ; $R_{GS} = 20 \text{k}\Omega$                              | -    | 55              | V    |
| V <sub>GS</sub>     | Continuous gate-source   | , ,   | -    | ± 15            | V    |
|                     | voltage                  |   |      |                 |      |
| $V_{GSM}$           | Peak pulsed gate-source  |   | -    | ± 20            | V    |
|                     | voltage                  |   |      |                 |      |
| I <sub>D</sub>      | Continuous drain current | $T_{mb} = 25  ^{\circ}\text{C};  V_{GS} = 5  \text{V}$<br>$T_{mb} = 100  ^{\circ}\text{C};  V_{GS} = 5  \text{V}$ | -    | 75 <sup>2</sup> | Α    |
|                     |                          | $T_{mb} = 100  ^{\circ}C;  V_{GS} = 5  V$   | -    | 75 <sup>2</sup> | Α    |
| I <sub>DM</sub>     | Pulsed drain current     | T <sub>mb</sub> = 25 °C   | -    | 240             | Α    |
| P <sub>D</sub>      | Total power dissipation  | $T_{mb} = 25  ^{\circ}C$  | -    | 230             | W    |
| $T_{i}$ , $T_{stg}$ | Operating junction and   |   | - 55 | 175             | °C   |
| , , ,               | storage temperature      |   |      |                 |      |

<sup>1</sup> It is not possible to make connection to pin:2 of the SOT404 package

<sup>2</sup> maximum current limited by package

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## THERMAL RESISTANCES

| SYMBOL               | PARAMETER                                    | CONDITIONS  | TYP.     | MAX.   | UNIT       |
|----------------------|--|---|----------|--------|------------|
| R <sub>th j-mb</sub> | Thermal resistance junction to mounting base |   | -        | 0.65   | K/W        |
| R <sub>th j-a</sub>  |  | SOT78 package, in free air<br>SOT404 package, pcb mounted, minimum<br>footprint | 60<br>50 | -<br>- | K/W<br>K/W |

## **AVALANCHE ENERGY LIMITING VALUES**

Limiting values in accordance with the Absolute Maximum System (IEC 134)

| SYMBOL | PARAMETER                        | CONDITIONS  | MIN. | MAX. | UNIT |
|--------|----------------------------------|---|------|------|------|
| 710    | Non-repetitive avalanche energy  | Unclamped inductive load, $I_{AS} = 75 \text{ A}$ ;<br>$t_p = 100  \mu\text{s}$ ; $T_j \text{ prior to avalanche} = 25 ^{\circ}\text{C}$ ;<br>$V_{DD} \le 15 \text{ V}$ ; $R_{GS} = 50 \Omega$ ; $V_{GS} = 5 \text{ V}$ | -    | 268  | mJ   |
| 7.0    | Non-repetitive avalanche current | 55 7 65   | -    | 75   | Α    |

## **ELECTRICAL CHARACTERISTICS**

T<sub>i</sub>= 25°C unless otherwise specified

| SYMBOL              | PARAMETER                   | CONDITIONS  | MIN. | TYP. | MAX. | UNIT    |
|---------------------|-----------------------------|---|------|------|------|---------|
| $V_{(BR)DSS}$       | Drain-source breakdown      | $V_{GS} = 0 \text{ V}; I_D = 0.25 \text{ mA};$                        | 55   | -    | -    | V       |
|                     | voltage                     | $T_j = -55^{\circ}C$  | 50   | -    | -    | V       |
| $V_{GS(TO)}$        | Gate threshold voltage      | $V_{DS} = V_{GS}$ ; $I_D = 1 \text{ mA}$                              | 1.0  | 1.5  | 2.0  | V       |
|                     |                             | T <sub>j</sub> = 175°C<br>T <sub>i</sub> = -55°C                      | 0.5  | -    | -    | V       |
| l_                  | <u>_</u> .                  |   | -    | -    | 2.3  | V       |
| R <sub>DS(ON)</sub> | Drain-source on-state       | $V_{GS} = 10 \text{ V}; I_{D} = 25 \text{ A}$                         | -    | 4.8  | 5.8  | mΩ      |
|                     | resistance                  | $V_{GS} = 5 \text{ V}; I_{D} = 25 \text{ A}$                          | -    | 5.3  | 6.3  | mΩ      |
|                     |                             | $V_{GS} = 4.5 \text{ V}; I_{D} = 25 \text{ A}$                        | -    | -    | 6.7  | mΩ      |
| ١.                  |                             | $V_{GS} = 5 \text{ V}; I_D = 25 \text{ A}; T_j = 175^{\circ}\text{C}$ | -    | -    | 13.2 | mΩ      |
| GSS                 | Gate source leakage current | $V_{GS} = \pm 10 \text{ V}; V_{DS} = 0 \text{ V}$                     | -    | 2    | 100  | nA<br>^ |
| DSS                 | Zero gate voltage drain     | $V_{DS} = 55 \text{ V}; V_{GS} = 0 \text{ V};$                        | -    | 0.05 | 10   | μΑ      |
|                     | current                     | T <sub>j</sub> = 175°C  | -    |      | 500  | μΑ      |
| $Q_{g(tot)}$        | Total gate charge           | $I_D = 75 \text{ A}; V_{DD} = 44 \text{ V}; V_{GS} = 5 \text{ V}$     | -    | 103  | -    | nC      |
| $Q_{gs}$            | Gate-source charge          |   | -    | 15   | -    | nC      |
| $Q_{gd}$            | Gate-drain (Miller) charge  |   | -    | 52   | -    | nC      |
| t <sub>d on</sub>   | Turn-on delay time          | $V_{DD} = 30 \text{ V}; R_D = 1.2 \Omega;$                            | -    | 45   | -    | ns      |
| t <sub>r</sub>      | Turn-on rise time           | $V_{GS} = 5 \text{ V}; R_G = 10 \Omega$                               | -    | 180  | -    | ns      |
| t <sub>d off</sub>  | Turn-off delay time         | Resistive load  | -    | 420  | -    | ns      |
| $t_{f}$             | Turn-off fall time          |   | -    | 235  | -    | ns      |
| L <sub>d</sub>      | Internal drain inductance   | Measured from tab to centre of die                                    | -    | 3.5  | -    | nΗ      |
| L <sub>d</sub>      | Internal drain inductance   | Measured from drain lead to centre of die                             | -    | 4.5  | -    | nΗ      |
|                     |                             | (SOT78 package only)  |      |      |      |         |
| L <sub>s</sub>      | Internal source inductance  | Measured from source lead to source                                   | -    | 7.5  | -    | nΗ      |
|                     |                             | bond pad  |      |      |      |         |
| C <sub>iss</sub>    | Input capacitance           | $V_{GS} = 0 \text{ V}; V_{DS} = 25 \text{ V}; f = 1 \text{ MHz}$      | -    | 6500 | -    | рF      |
| Coss                | Output capacitance          |   | -    | 1500 | -    | pF      |
| C <sub>rss</sub>    | Feedback capacitance        |   | -    | 700  | -    | pF      |



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## **REVERSE DIODE LIMITING VALUES AND CHARACTERISTICS**

T<sub>i</sub> = 25°C unless otherwise specified

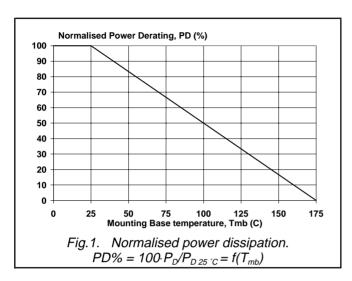
| SYMBOL                          | PARAMETER  | CONDITIONS  | MIN.   | TYP.        | MAX.     | UNIT     |
|---------------------------------|--|---|--------|-------------|----------|----------|
| I <sub>S</sub>                  | Continuous source current (body diode)           |   | -      | -           | 75       | Α        |
| I <sub>SM</sub>                 | Pulsed source current (body diode)               |   | -      | -           | 240      | Α        |
| $V_{SD}$                        | Diode forward voltage                            | $I_F = 25 \text{ A}; V_{GS} = 0 \text{ V}$<br>$I_F = 75 \text{ A}; V_{GS} = 0 \text{ V}$                  | -<br>- | 0.85<br>1.1 | 1.2<br>- | V<br>V   |
| t <sub>rr</sub> Q <sub>rr</sub> | Reverse recovery time<br>Reverse recovery charge | $I_F = 20 \text{ A}; -dI_F/dt = 100 \text{ A/}\mu\text{s};$<br>$V_{GS} = 0 \text{ V}; V_R = 30 \text{ V}$ |        | 80<br>0.2   | -        | ns<br>μC |

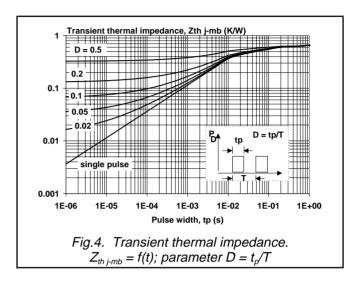
Philips Semiconductors Product specification

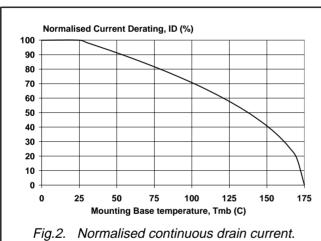
# Silicon

# N-channel logic level TrenchMOS<sup>TM</sup> transistor

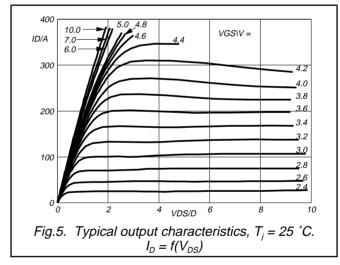
## PSMN005-55B, PSMN005-55P

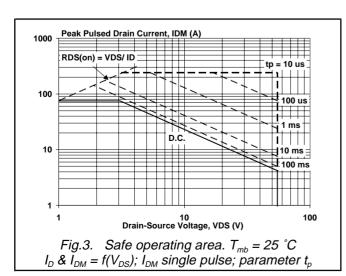


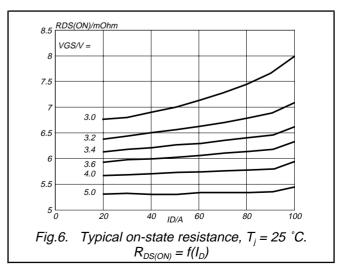




 $ID\% = 100 \cdot I_D/I_{D \cdot 25 \, ^{\circ}C} = f(T_{mb}); conditions: V_{GS} \ge 5 \, V$ 





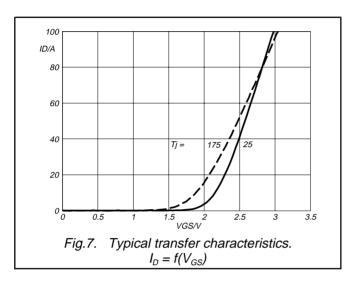


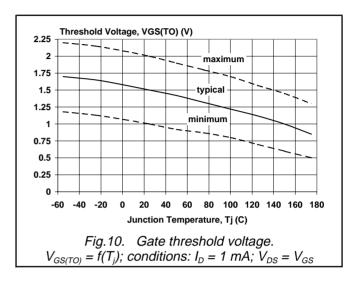
Philips Semiconductors Product specification

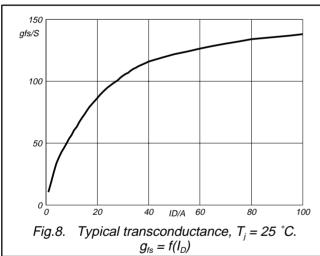
# Silicon

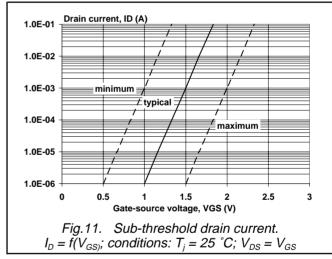
# N-channel logic level TrenchMOS<sup>TM</sup> transistor

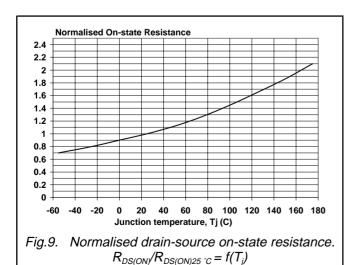
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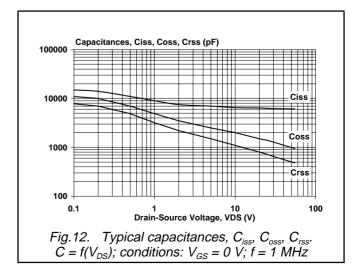












# N-channel logic level TrenchMOS<sup>TM</sup> transistor

# PSMN005-55B, PSMN005-55P

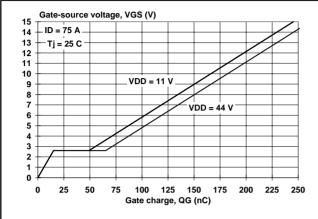


Fig.13. Typical turn-on gate-charge characteristics.  $V_{GS} = f(Q_G)$ 

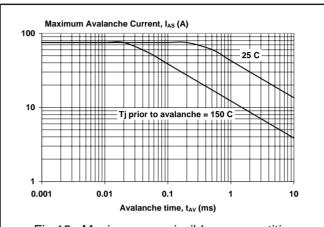
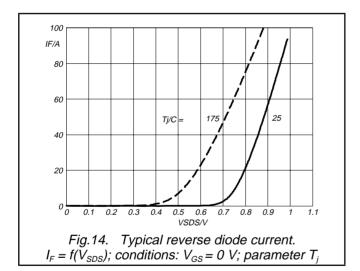


Fig.15. Maximum permissible non-repetitive avalanche current ( $I_{AS}$ ) versus avalanche time ( $t_{AV}$ ); unclamped inductive load

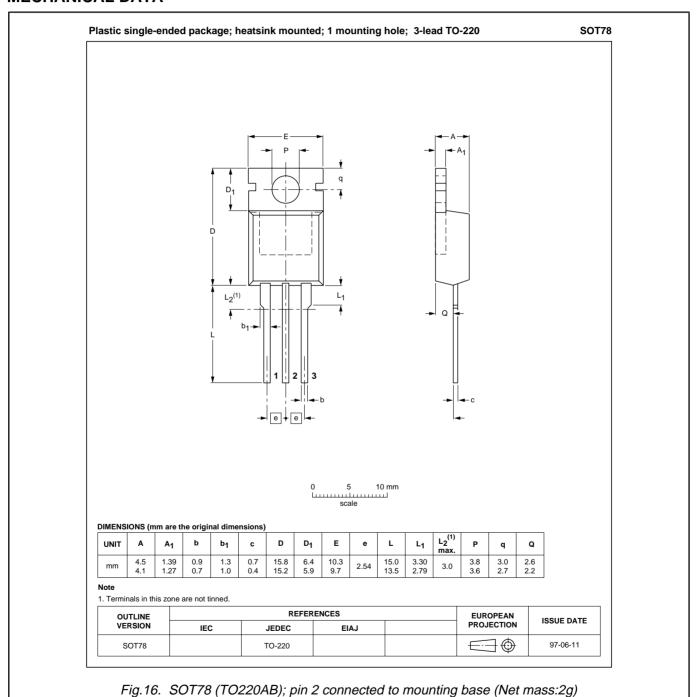


# Silicon MAX

N-channel logic level TrenchMOS<sup>TM</sup> transistor

PSMN005-55B, PSMN005-55P

## **MECHANICAL DATA**



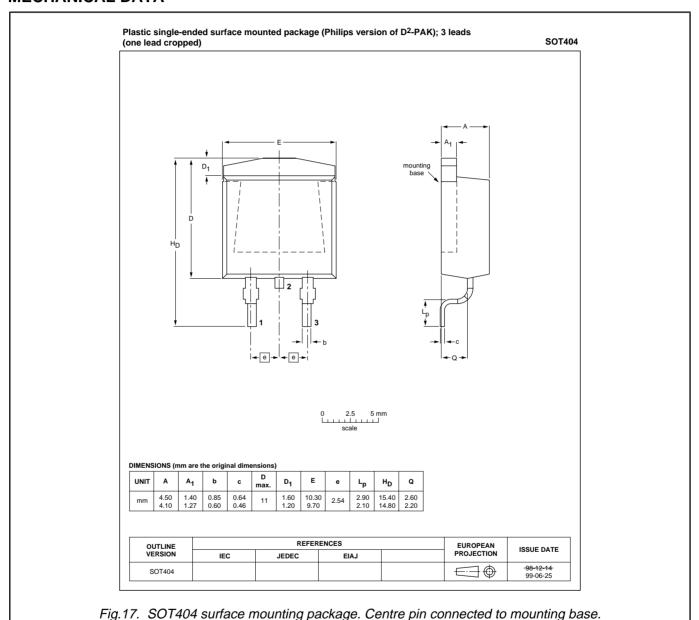
#### **Notes**

- 1. This product is supplied in anti-static packaging. The gate-source input must be protected against static discharge during transport or handling.
- 2. Refer to mounting instructions for SOT78 (TO220AB) package.
- 3. Epoxy meets UL94 V0 at 1/8".

N-channel logic level TrenchMOS<sup>TM</sup> transistor

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### **MECHANICAL DATA**



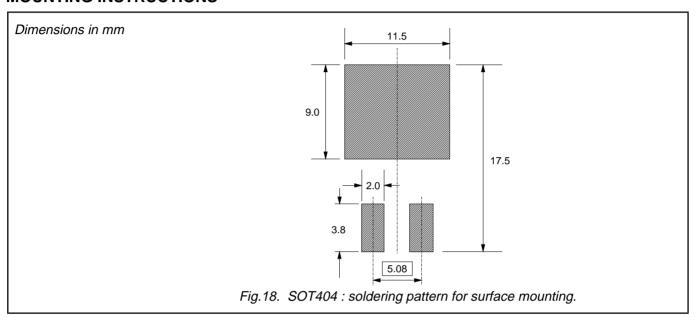
#### **Notes**

- 1. This product is supplied in anti-static packaging. The gate-source input must be protected against static discharge during transport or handling.
- 2. Refer to SMD Footprint Design and Soldering Guidelines, Data Handbook SC18.
- 3. Epoxy meets UL94 V0 at 1/8".

N-channel logic level TrenchMOS<sup>TM</sup> transistor

PSMN005-55B, PSMN005-55P

#### MOUNTING INSTRUCTIONS



### **DEFINITIONS**

| Data sheet status   |  |  |  |  |
|---|--|--|--|--|
| Objective specification This data sheet contains target or goal specifications for product development.     |  |  |  |  |
| Preliminary specification This data sheet contains preliminary data; supplementary data may be published la |  |  |  |  |
| Product specification   | This data sheet contains final product specifications. |  |  |  |

### Limiting values

Limiting values are given in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of this specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

#### **Application information**

Where application information is given, it is advisory and does not form part of the specification.

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